DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Electronic Version v11
Stylesheet Version v10

Title of Invention

CHIP-PACKAGING WITH BONDING OPTIONS HAVING A PLURALITY OF PACKAGE SUBSTRATES

As the below named inventor, I declare that:

This declaration is directed to the invention titled: "CHIP-PACKAGING WITH BONDING OPTIONS HAVING A PLURALITY OF PACKAGE SUBSTRATES"

I believe that I am the original and first inventor of the subject matter which is claimed and for which a patent is sought;

I have reviewed and understand the contents of the above-identified application, including the claims, as amended by any amendment specifically referred to above;

I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT International filing date of the continuation-in-part application.

All statements made herein of my knowledge are true, all statements made herein on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001, and may jeopardize the validity of the application or any patent issuing thereon.

FULL NAME OF INVENTOR:

Inventor: Cheng-Yen Huang	Inventor
Signature :	Citizen of : TW

COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

I believe I am the sole (if only one name appears below), or joint (if more than one name appears), original and first inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

"CHIP-PACKAGING WITH BONDING OPTIONS HAVING A PLURALITY OF PACKAGE SUBSTRATES"

+ The specification	for the above en	titled invention is filed herewith.
The specification	for the above en	titled invention was filed previously
with application serial numb	er:	Filing Date:
		nd understand the contents of the above identified ed by any amendment referred to above.
the invention disclosed in Regulations, Section 1.56 application to disclose to th to the patentability of the	this application in (a). I further ack to Patent and Trader invention disclosed	ormation which is material to the patentability of in accordance with Title 37, Code of Federal mowledge the duty in any continuation-in-part mark Office all information known to be material d in this application, as defined in 1.56, which of the prior application and the filing date of this
	<u>PRIOR</u>	ITY CLAIM
There is no claim of	f priority	
Claim of priority is	based on the fol	lowing:
	POWER OF	F ATTORNEY
		point the following attorneies to prosecute this in the Patent and Trademark Office:
Winston Hsu Registration# 41,526		

Combined Declaration and Power of Attorney, Page 1 of 2

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DECLARATION

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued hereon.

(請發明人務必簽署日期)

Date: Apr. 15, 2004

Printed Nam

Printed Name:

Post Office Address: and Residence

Citizen of:

Cheng-Yen, Huang Cheng-Yen Huang

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Taiwan, R.O.C.

R.O.C.

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